

8-Bit Bidirectional Voltage-Level Translator with Auto Direction Sensing and ±15kV ESD Protection UM3308 CSP20 2.7×2.4 UM3308H CSP20 2.4×1.9

General Description

UM3308/UM3308H is 8-channel bidirectional voltage level translator with auto direction sensing and $\pm 15 \mathrm{kV}$ ESD protection. This 8-channel non-inverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65V to 5.5V. This allows for universal low-voltage bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, and 5V voltage nodes. Both I/O ports are auto-sensing; thus, no direction pin is required, making it ideal for data transfer between low-voltage ASICs/PLDs and higher voltage systems.

The UM3308/UM3308H operates at a guaranteed data rate of 20Mbps over the entire specified operating voltage range. Within specific voltage domains, higher data rates are up to 100Mbps. When the output-enable (OE) input is low, all outputs are placed in the high-impedance state. The

UM3308/UM3308H is designed so that the OE input circuit is supplied by V_{CCA} .

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The UM3308 is 8-channel level translator available in CSP20 2.7×2.4 bump package while the UM3308H is available in CSP20 2.4×1.9 bump package. The UM3308H includes wafer backside coating process, making the chip more unbreakable.

Applications

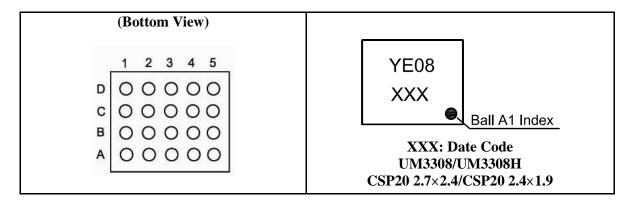
- Low-Voltage ASIC Level Translation
- Cell-Phone Cradles
- Portable POS Systems
- Portable Communication Devices
- Low-Cost Serial Interfaces
- Cell-Phones
- GPS
- Telecommunications Equipment

Features

- 1.2V to 3.6V on A Port and 1.65V to 5.5V on B Port ($V_{CCA} \le V_{CCB}$)
- V_{CC} Isolation Feature If Either V_{CC} Input is at GND, All Outputs are in the High-Impedance State
- OE Input Circuit Referenced to V_{CCA}
- Low Power Consumption
- Latch-Up Performance Exceeds 100mA
- ±15kV ESD Protection on B Ports

Pin Configurations

Top View



Ball Mapping for UM3308/UM3308H

| | 5 | 4 | 3 | 2 | 1 |
|---|-----|----|----|----|------------------|
| D | B8 | B6 | B4 | B2 | V _{CCB} |
| С | GND | B7 | B5 | В3 | B1 |
| В | OE | A7 | A5 | А3 | A1 |
| Α | A8 | A6 | A4 | A2 | V_{CCA} |

Transparent Top View

Pin Description

| Pin Name | Function |
|-----------|--|
| A1 | Input/Output 1. Referenced to V _{CCA} |
| V_{CCA} | A-Port Supply Voltage. $1.1V \le V_{CCA} \le 3.6V$ and $V_{CCA} \le V_{CCB}$ |
| A2 | Input/Output 2. Referenced to V _{CCA} |
| A3 | Input/Output 3. Referenced to V _{CCA} |
| A4 | Input/Output 4. Referenced to V _{CCA} |
| A5 | Input/Output 5. Referenced to V _{CCA} |
| A6 | Input/Output 6. Referenced to V _{CCA} |
| A7 | Input/Output 7. Referenced to V _{CCA} |
| A8 | Input/Output 8. Referenced to V _{CCA} |
| OE | 3-State Output Enable. Pull OE low to place all outputs in 3-state mode. |
| OE | Referenced to V _{CCA} |
| GND | Ground |
| B8 | Input/Output 8. Referenced to V _{CCB} |
| B7 | Input/Output 7. Referenced to V _{CCB} |
| В6 | Input/Output 6. Referenced to V _{CCB} |
| B5 | Input/Output 5. Referenced to V _{CCB} |
| B4 | Input/Output 4. Referenced to V _{CCB} |
| В3 | Input/Output 3. Referenced to V _{CCB} |
| B2 | Input/Output 2. Referenced to V _{CCB} |
| V_{CCB} | B-Port Supply Voltage. 1.65V≤V _{CCB} ≤5.5V |
| B1 | Input/Output 1. Referenced to V _{CCB} |

Ordering Information

| Part Number | Packaging Type | Marking Code | Shipping Qty |
|-------------|----------------|--------------|------------------------------|
| UM3308 | CSP20 2.7×2.4 | YE08 | 2500pcs/7Inch Tape & Reel |
| UM3308H | CSP20 2.4×1.9 | YE08 | 3000pcs/7Inch Tape & Reel |

Absolute Maximum Ratings (Note 1)

Over operating free-air temperature range (unless otherwise noted)

| Symbol | Parameter | | Value | Unit | |
|------------------|--|-------------|---------------------------|------|--|
| V_{CCA} | Supply Voltage Range | | -0.5 to +4.5 | V | |
| V _{CCB} | Supply Voltage Range | | -0.5 to +6.5 | V | |
| $V_{\rm I}$ | Input Voltage Range (Note 2) | A ports | -0.5 to +4.5 | V | |
| V 1 | input voltage Range (1vote 2) | B ports | -0.5 to +6.5 | • | |
| V_{o} | Voltage Range Applied to Any Output in the High-Impedance or | A ports | -0.5 to +4.5 | V | |
| • 0 | Power-Off State (Note 2) | B ports | -0.5 to +6.5 | V | |
| V | Voltage Range Applied to Any | A ports | -0.5 to $(V_{CCA}+0.5)$ | V | |
| V_{o} | Output in the High or Low State (Note 2, 3) | B ports | -0.5 to $(V_{CCB}+0.5)$ | ' | |
| I_{IK} | Input Clamp Current | $V_I < 0$ | -50 | mA | |
| I_{OK} | Output Clamp Current | $V_0 < 0$ | -50 | mA | |
| I_{O} | Continuous Output Current | | ±50 | mA | |
| | Continuous Current through V _{CCA} , V _{CCA} | CCB, or GND | ±100 | mA | |
| $	heta_{ m JA}$ | Package Thermal Impedance | 78 | °C/W | | |
| T_{OP} | Operating Temperature Range | | -40 to +85 | °C | |
| T_{STG} | Storage Temperature Range | | -65 to +150 | °C | |

- Note 1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- Note 2: The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- Note 3: The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

Recommended Operating Conditions (Note 1, 2)

| Symbol | Parame | eter | V _{CCA} | V_{CCB} | Min | Max | Unit |
|---------------------|--|---------------|------------------|---------------|-------------------------------|------------------|------|
| V_{CCA} | Cumple: V | altaga | | | 1.2 | 3.6 | V |
| V_{CCB} | Supply V | ortage | | | 1.65 | 5.5 | V |
| | High Level Input | Data Inputs | 1.2V to 3.6V | 1.65V to 5.5V | $V_{CCI} \times 0.65 (Note3)$ | V _{CCI} | V |
| V_{IH} | Voltage | OE | 1.2V to 3.6V | 1.65V to 5.5V | $V_{CCA} \times 0.65$ | 5.5 | V |
| V | Low Level Input | Data Inputs | 1.2V to 5.5V | 1.65V to 5.5V | 0 V_{CC} | 20.35 | V |
| $V_{ m IL}$ | Voltage | OE | 1.2V to 3.6V | 1.65V to 5.5V | V_{CC} | $\times 0.35$ | V |
| | I | A-Port Inputs | 1.2V to 3.6V | 1.65V to 5.5V | | 40 | |
| $\Delta t/\Delta V$ | Input Transition Rise or Fall Time B-Port Inputs | 1.00/4 2.60/ | 1.65V to 3.6V | | 40 | ns/V | |
| | | D-FOIT Inputs | 1.2V to 3.6V | 4.5V to 5.5V | | 30 | |

- Note 1: The A and B sides of an unused data I/O pair must be held in the same state, i.e., both at V_{CCI} or both at GND.
- Note 2: V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.
- Note 3: V_{CCI} is the supply voltage associated with the input port.

Electrical Characteristics (Note 1, 2)

Over recommended operating free-air temperature range (unless otherwise noted)

| Parameter ' | | Test Conditions | X 7 | X 7 | $T_A = 1$ | 25 ℃ | -40°C to | 85°C | Unit |
|---|-----------------------------|---|---------------|---------------|-----------|-------------|----------------|------|------|
| F | arameter | Test Conditions | V_{CCA} | V_{CCB} | Тур | Max | Min | Max | Umt |
| | V_{OHA} | I _{OH} =-20μA | 1.2V | | 1.1 | | | | V |
| | ▼ OHA | 10H=-20μΑ | 1.4V to 3.6V | | | | V_{CCA} -0.4 | | v |
| | V_{OLA} | I _{OL} =20μA | 1.2V | | 0.3 | | | | V |
| | · | | 1.4V to 3.6V | | | | | 0.4 | |
| | V_{OHB} | I_{OH} =-20 μA | | 1.65V to 5.5V | | | V_{CCB} -0.4 | | V |
| | V_{OLB} | I _{OL} =20μA | | 1.65V to 5.5V | | | | 0.4 | V |
| I_{I} | OE | | 1.2V to 3.6V | 1.65V to 5.5V | | ±1 | | ±2 | μΑ |
| $ m I_{off}$ | A Port | | 0V | 0V to 5.5V | | ±1 | | ±2 | μΑ |
| 1 off | B Port | | 0V to 3.6V | 0V | | ±1 | | ±2 | μΑ |
| I_{OZ} | A or B Port | OE=GND | 1.2V to 3.6V | 1.65V to 5.5V | | ±1 | | ±2 | μΑ |
| | | | 1.2V | 1.65V to 5.5V | 0.06 | | | | |
| | т | $V_I = V_{CCI}$ or GND | 1.4V to 3.6V | 1.65V to 5.5V | | | | 5 | 4 |
| | I_{CCA} | $I_O=0$ | 3.6V | 0V | | | | 2 | μΑ |
| | | | 0V | 5.5V | | | | -2 | |
| | | | 1.2V | 1.65V to 5.5V | 3.5 | | | | |
| | т | V _I =V _{CCI} or GND | 1.4V to 3.6V | 1.65V to 5.5V | | | | 5 | |
| | I_{CCB} | $I_0=0$ | 3.6V | 0V | | | | -2 | μΑ |
| | | | 0V | 5.5V | | | | 2 | |
| | T . T | V _I =V _{CCI} or GND | 1.2V | 1.65V to 5.5V | 3.5 | | | | 4 |
| - | $I_{CCA}+I_{CCB}$ | $I_{O}=0$ | 1.4V to 3.6V | 1.65V to 5.5V | | | | 10 | μΑ |
| | T | V _I =V _{CCI} or GND | 1.2V | 1.65V to 5.5V | 0.05 | | | | μA |
| | I_{CCZA} $I_0=0$, OE=GND | | 1.4V to 3.6V | 1.65V to 5.5V | | | | 5 | μΑ |
| I _{CCZB} V _I =V _{CCI} or GND | | 1.2V | 1.65V to 5.5V | 3.5 | | | | 1 | |
| | 10-0, OL-011D | | 1.4V to 3.6V | 1.65V to 5.5V | | | | 5 | μA |
| C_{i} | OE | | 1.2V to 3.6V | 1.65V to 5.5V | 5 | | | 5.5 | pF |
| C_{iO} | A Port B Port | | 1.2V to 3.6V | 1.65V to 5.5V | 5 8 | | | 6.5 | pF |

Note 1: V_{CCI} is the supply voltage associated with the input port. Note 2: V_{CCO} is the supply voltage associated with the output port.

Switching Characteristics

 $T_A = +25 \,^{\circ}\text{C}, V_{CCA} = 1.2 \text{V}$

| Parameter | From | To | $V_{CCB}=1.8V$ | $V_{CCB}=2.5V$ | $V_{CCB}=3.3V$ | $V_{CCB}=5V$ | Unit |
|-------------------------|------------------------------|--------------------|----------------|----------------|----------------|--------------|------|
| 1 at afficter | (Input) | (Output) | Тур | Тур | Тур | Тур | Omt |
| 4 | A | В | 7 | 6 | 5.3 | 5.5 | ne |
| $t_{\rm pd}$ | В | A | 7.5 | 6.5 | 6 | 6 | ns |
| + | OE | A | 1 | 1 | 1 | 1 | 110 |
| ι _{en} | t _{en} OE | | 1 | 1 | 1 | 1 | μs |
| 4 | , OF | | 18 | 16 | 14 | 14 | ma |
| $t_{ m dis}$ | OE | В | 19 | 17 | 15 | 15 | ns |
| t_{rA}, t_{fA} | | se and Fall me | 5 | 5 | 5 | 5 | ns |
| $t_{\rm rB,}t_{\rm fB}$ | B Port Rise and Fall Time | | 2.5 | 1.5 | 1.2 | 1 | ns |
| $t_{SK(O)}$ | Channel-te | Channel-to-Channel | | 0.5 | 0.5 | 1.5 | ns |
| Max Data Rate | | | 20 | 20 | 20 | 20 | Mbps |

Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =1.5V±0.1V (unless otherwise noted)

| Parameter | From (Input) | To | V_{CCB} =1.8V ±0.15V | | $V_{\text{CCB}} = 2.5 \text{V}$ $\pm 0.2 \text{V}$ | | V_{CCB} =3.3V ± 0.3 V | | $V_{CCB}=5V$ $\pm 0.5V$ | | Unit |
|--------------------|------------------------------|----------|---------------------------|-----|--|-----|------------------------------------|-----|----------------------------|-----|------|
| | | (Output) | Min | Max | Min | Max | Min | Max | Min | Max | |
| 4 | A | В | 2 | 15 | 1.2 | 11 | 1.1 | 10 | 1 | 10 | ng |
| t_{pd} | В | A | 1 | 15 | 0.9 | 12 | 0.5 | 12 | 0.3 | 13 | ns |
| t _{en} OE | | A | | 1 | | 1 | | 1 | | 1 | 110 |
| t _{en} | OE | В | | 1 | | 1 | | 1 | | 1 | μs |
| 4 | OE | A | 6 | 30 | 5.5 | 28 | 5.5 | 25 | 5.5 | 23 | ne |
| $t_{ m dis}$ | | В | 5.5 | 30 | 5 | 25 | 5 | 20 | 5 | 20 | ns |
| t_{rA}, t_{fA} | A Port Rise and Fall Time | | 1.5 | 5.0 | 1.5 | 5.0 | 1.5 | 5.0 | 1.5 | 5.0 | ns |
| t_{rB}, t_{fB} | B Port Rise and Fall Time | | 0.9 | 4.5 | 0.6 | 3.5 | 0.5 | 3 | 0.4 | 2.5 | ns |
| $t_{SK(O)}$ | Channel-to-Channel | | | 0.5 | | 0.5 | | 0.5 | | 0.5 | ns |
| Max Data Rate | | | 40 | | 40 | | 40 | | 40 | · | Mbps |

Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =1.8V±0.15V (unless otherwise noted)

| Parameter | From | To (Output) | $\begin{array}{c} V_{CCB} = 1.8V \\ \pm 0.15V \end{array}$ | | V_{CCB} =2.5V ±0.2V | | V_{CCB} =3.3V ± 0.3 V | | V _{CCB} =5V ±0.5V | | Unit |
|------------------|------------------------------|-------------|--|-----|--------------------------|-----|------------------------------------|------|-------------------------------|------|---------|
| | (Input) | (Output) | Min | Max | Min | Max | Min | Max | Min | Max | |
| 4 | A | В | 1.6 | 10 | 1.4 | 9 | 1.3 | 7 | 1.2 | 6.5 | |
| t_{pd} | В | A | 1.5 | 12 | 1.3 | 8.5 | 1 | 8 | 0.9 | 8 | ns |
| + | OE | A | | 1 | | 1 | | 1 | | 1 | 110 |
| t _{en} | OE | В | | 1 | | 1 | | 1 | | 1 | μs |
| 4 | OE | A | 6 | 34 | 5.5 | 23 | 5 | 20 | 5 | 17.6 | ne |
| $t_{ m dis}$ | OL | В | 5.5 | 33 | 4.5 | 22 | 4.2 | 16.8 | 4.4 | 16.3 | ns |
| t_{rA}, t_{fA} | A Port Rise and Fall Time | | 1 | 4.2 | 1.1 | 4.0 | 1.1 | 4.0 | 1.1 | 4.0 | ns |
| t_{rB}, t_{fB} | B Port Rise and Fall Time | | 0.9 | 4 | 0.6 | 3.2 | 0.5 | 2.8 | 0.4 | 2.8 | ns |
| $t_{SK(O)}$ | Channel-to-Channel | | | 0.5 | | 0.5 | | 0.5 | | 0.5 | ns |
| Max Data Rate | | | 60 | | 60 | | 60 | | 60 | | Mbps |

Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =2.5V±0.2V (unless otherwise noted)

| Parameter | From | To (Output) | V_{CCB} =2.5V ±0.2V | | V_{CCB} =3.3V ± 0.3 V | | V_{CCB} =5V ±0.5V | | Unit | |
|--------------------------|---------------|--------------|---------------------------------|-----|------------------------------------|------|------------------------|------|------|--|
| | (Input) | (Output) | Min | Max | Min | Max | Min | Max | | |
| + | A | В | 1.1 | 6.5 | 1 | 5.2 | 0.9 | 5 | nc | |
| t_{pd} | В | A | 1.2 | 6.6 | 1.1 | 5.1 | 0.9 | 4.4 | ns | |
| , OF | | A | | 1 | | 1 | | 1 | 110 | |
| t _{en} | OE | В | | 1 | | 1 | | 1 | μs | |
| 4 | OE | A | 5.0 | 23 | 4.6 | 15.2 | 4.6 | 13 | | |
| $t_{ m dis}$ | OE | В | 4.4 | 22 | 3.8 | 16 | 3.9 | 13.3 | ns | |
| t_{rA}, t_{fA} | A Port Rise a | nd Fall Time | 0.8 | 3 | 0.8 | 3 | 0.8 | 3 | ns | |
| $t_{\rm rB}, t_{\rm fB}$ | B Port Rise a | nd Fall Time | 0.7 | 2.7 | 0.5 | 2.8 | 0.4 | 2.7 | ns | |
| t _{SK(O)} | Channel-to | | 0.5 | | 0.5 | | 0.5 | ns | | |
| Max Data Rate | | | 100 | | 100 | | 100 | | Mbps | |



Switching Characteristics

Over recommended operating free-air temperature range, V_{CCA} =3.3V±0.3V (unless otherwise noted)

| Parameter | From | To (Output) | | =3.3V .3V | $V_{CCB}=5V$ $\pm 0.5V$ | | Unit | |
|---------------------|---------------|---------------------------|-----|--------------|----------------------------|------|------|--|
| | (Input) | (Output) | Min | Max | Min | Max | | |
| 4 | A | В | 0.9 | 5 | 0.8 | 4 | *** | |
| $t_{\rm pd}$ | В | A | 1 | 5.1 | 0.9 | 4 | ns | |
| 4 | OE | A | | 1 | | 1 | 110 | |
| t _{en} | OE | В | | 1 | | 1 | μs | |
| 4 | OE | A | 5 | 15 | 4 | 13 | ma. | |
| $t_{ m dis}$ | OE | В | 4 | 16 | 3.4 | 13.8 | ns | |
| t_{rA}, t_{fA} | A Port Rise a | nd Fall Time | 0.7 | 2.5 | 0.7 | 2.5 | ns | |
| t_{rB} , t_{fB} | B Port Rise a | B Port Rise and Fall Time | | 2.1 | 0.4 | 2.8 | ns | |
| $t_{SK(O)}$ | Channel-to | | 0.5 | | 0.5 | ns | | |
| Max Data Rate | | | 100 | | 100 | | Mbps | |



Applications Information

UM3308/UM3308H ESD protected level translator provides level shifting necessary to allow data transfer in a multi-voltage system. Externally applied voltages, V_{CCA} and V_{CCB} set the logic levels on either side of device. A low voltage signal present on V_{CCA} side of the device appears as a high voltage logic signal on the V_{CCB} side of the device, and vice-versa.

Block Diagram

The UM3308/UM3308H (block diagram see Figure 1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a dc state, the output drivers of the UM3308/UM3308H can maintain a high or low, but are designed to be weak, so that they can be overdriven by an external driver when data on the bus starts flowing to the opposite direction. The output one shot detects rising or falling edges on the A or B ports. During a rising edge, the one shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition.

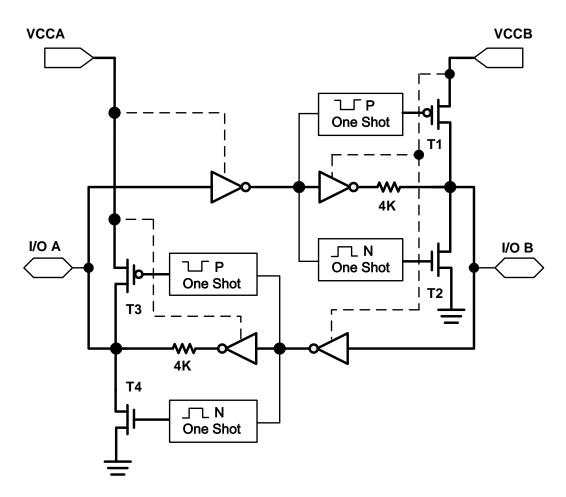
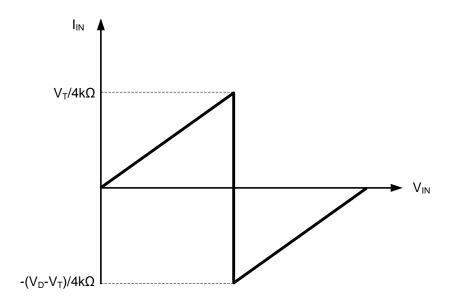


Figure 1 Block Diagram of UM3308/UM3308H I/O Cell

Input Driver Requirements

Typical I_{IN} vs V_{IN} characteristics of the UM3308/UM3308H are shown in Figure 2. For proper operation, the device driving the data I/Os of the UM3308/UM3308H must have drive strength of at least $\pm 2mA$.



A: V_T is the input threshold voltage of the UM3308/UM3308H (typical $V_{CCI}/2$). B: V_D is the supply voltage of the external driver.

Figure 2 Typical I_{IN} vs. V_{IN} Curve

Power Up

During operation, ensure that $V_{CCA} \le V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \ge V_{CCB}$ does not damage the device, so any power supply can be ramped up first. The UM3308/UM3308H has circuitry that disables all output ports when either V_{CC} is switched off $(V_{CCA/B} = 0 \text{ V})$.

Enable and Disable

The UM3308/UM3308H has an OE input that is used to disable the device by setting OE=low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

Pull-up or Pull-down Resistors on I/O Lines

The UM3308/UM3308H is designed to drive capacitive loads of up to 50pF. The output drivers of the UM3308/UM3308H have low dc drive strength. If pull-up or pull-down resistors are connected externally to the data I/Os, their values must be kept higher than $50k\Omega$ to ensure that they do not contend with the output drivers of theUM3308/UM3308H.

For the same reason, the UM3308/UM3308H should not be used in applications such as I^2C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O.

Typical Operating Circuit

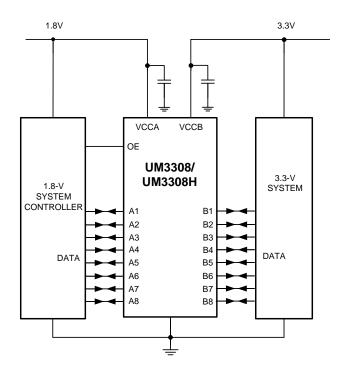
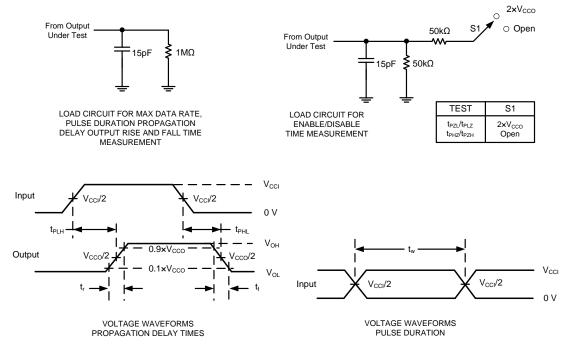


Figure 3 Typical Operating Circuit

Test Circuits



- A. C_L includes probe and jig capacitance. B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10MHz, $Z_0=50\Omega$,dv/dt \geq 1V/ns. C. The outputs are measured one at a time, with one transition per measurement.

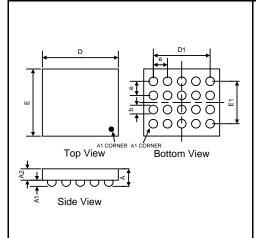
- D. t_{PLH} and t_{PHL} are the same as t_{pd} . E. V_{CCI} is the V_{CC} associated with the input port.
- F. V_{CCO} is the V_{CC} associated with the output port. G. All parameters and waveforms are not applicable to all devices.

Figure 4 Load Circuits and Voltage Waveforms

Package Information

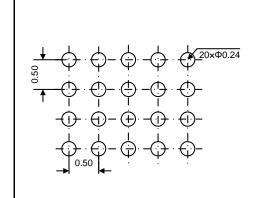
UM3308: CSP20 2.7×2.4

Outline Drawing



| | DIMENSIONS | | | | | | | | | | | |
|------------|------------|---------|------|----------|----------|--------|--|--|--|--|--|--|
| Causala al | MIL | LIMET | ERS | | INCHES | | | | | | | |
| Symbol | Min | Тур | Max | Min | Тур | Max | | | | | | |
| A | - | 0.61 | 0.63 | - | 0.024 | 0.025 | | | | | | |
| A1 | 0.21 | 0.231 | 0.24 | 0.0083 | 0.0091 | 0.0094 | | | | | | |
| A2 | 0.37 | 0.38 | 0.39 | 0.014 | 0.015 | 0.016 | | | | | | |
| b | 0.27 | 0.30 | 0.32 | 0.011 | 0.012 | 0.013 | | | | | | |
| D | 2.60 | 2.71 | 2.80 | 0.102 | 0.107 | 0.110 | | | | | | |
| D1 | | 2.00BSC | | (| 0.079BSC | 1 | | | | | | |
| Е | 2.28 | 2.38 | 2.48 | 0.090 | 0.094 | 0.098 | | | | | | |
| E1 | | 1.50BSC | 7 | 0.059BSC | | | | | | | | |
| e | | 0.50BSC | 7 | 0.020BSC | | | | | | | | |

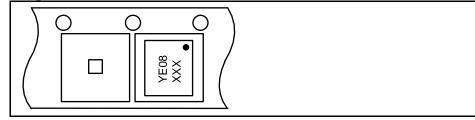
Land Pattern



NOTES:

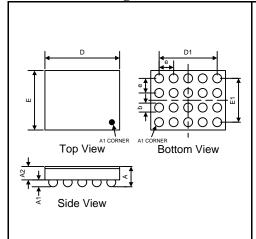
- 1. Bump is Lead Free Sn/Ag/Cu.
- 2. Unit: mm.
- 3. Non-solder mask defined copper landing pad.
- 4. Laser Mark on silicon die back; back-lapped.

Tape and Reel Orientation



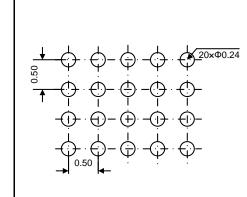
UM3308H: CSP20 2.4×1.9

Outline Drawing



| DIMENSIONS | | | | | | |
|------------|-------------|-------|------|----------|--------|--------|
| Symbol | MILLIMETERS | | | INCHES | | |
| | Min | Тур | Max | Min | Тур | Max |
| A | - | - | 0.68 | - | - | 0.027 |
| A1 | 0.21 | 0.231 | 0.24 | 0.0083 | 0.0091 | 0.0094 |
| A2 | 0.40 | 0.42 | 0.44 | 0.0157 | 0.0165 | 0.0173 |
| b | 0.27 | 0.30 | 0.32 | 0.011 | 0.012 | 0.013 |
| D | 2.32 | 2.35 | 2.40 | 0.091 | 0.093 | 0.094 |
| D1 | 2.00BSC | | | 0.079BSC | | |
| Е | 1.82 | 1.85 | 1.90 | 0.072 | 0.073 | 0.075 |
| E1 | 1.50BSC | | | 0.059BSC | | |
| e | 0.50BSC | | | 0.020BSC | | |

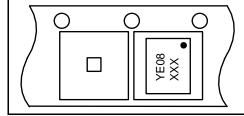
Land Pattern



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Tape and Reel Orientation



12/13

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All Union components are compliant with the RoHS directive, which helps to support customers in their compliance with environmental directives. For more green compliance information, please visit:

http://www.union-ic.com/index.aspx?cat_code=RoHSDeclaration

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